

DCBA

tb_frame_A3_J_ME_S
Rev G 2012/01/25

REVISED EC NO: J2014-0889 DRWNE-SATO CHK-DASHI-MOTSU APPR-NAKITA	2013/11/21	2013/11/21	2013/11/21	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION			
	10 UNDER		± 0.2		T. UENO	2004/05/17	TITLE CFA CARD CONN. 50P HEADER ASSY -LEAD FREE-							
	10 OVER 30 UNDER		± 0.25		CHECKED BY M. SASAO	DATE 2004/05/17								
	30 OVER		± 0.3		APPROVED BY M. SASAO	DATE 2004/05/17								
	ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.							SHEET NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE			SD-53927-001						1 OF 2		
	A	SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION												

NOTES

1. 材質

MATERIAL

ハウジング：ガラス入りLCP UL94V-0

HOUSING: LCP G.F. UL94V-0

ピン：リン青銅

PIN: PHOSPHOR BRONZE

ネール：リン青銅

NAIL: PHOSPHOR BRONZE

2. メッキ仕様

PLATING

PIN 接点部：パラジウムニッケル下地、金メッキ

CONTACT AREA: Au OVER Pd-Ni

半田付け部：錫メッキ

SOLDER TAIL AREA: TIN

下地メッキ：ニッケルメッキ

UNDERPLATING: NICKEL OVER ALL

NAIL 錫メッキ

TIN

下地メッキ：ニッケルメッキ

UNDERPLATING: NICKEL OVER ALL

3. 推奨基板厚

RECOMMENDED P.C.B. THICKNESS: ± 0.8 MIN.

4. 適合カード厚

RECOMMENDED CARD THICKNESS

接続部： 3.3 ± 0.1

CONNECTING AREA: 3.3 ± 0.1

5. 適合カード幅

RECOMMENDED CARD WIDTH: 42.8 ± 0.1

6. ハウジング色

HOUSING COLOR: WHITE

寸 1, 13, 38, 50

THIS DIMENSION APPLIES TO CIRCUIT NUMBERS

1, 13, 38 AND 50.

25, 26

THIS DIMENSION APPLIES TO CIRCUIT NUMBERS 25 AND 26.

ピンの倒れは、ピン根元を基準に全方向へ 0.1 MAX. とする。

PIN TIP LEAN TOWARD ANY DIRECTION NOT TO EXCEED 0.1

WHEN MEASURED FROM PIN BASE.

ピン根元に適用する。

THIS DIMENSION TO BE MEASURED AT PIN BASE.

ソルダーテールは、Z面を基準とし上へ 0.05 下へ 0.2 の範囲にあり、

且つソルダーテールの平坦度は、 0.15 MAX. とし、テール先端にて測定する。

SOLDERTAILS TO BE WITHIN 0.05 UPWARD AND

0.2 DOWNWARD FROM Z-DATUM PLACE, AND COPLANARITY OF

SOLDERTAILS TO BE WITHIN 0.15 .

MEASUREMENT POINT IS SOLDERTAILS TIP.

公差非累積

NON-CUMULATIVE

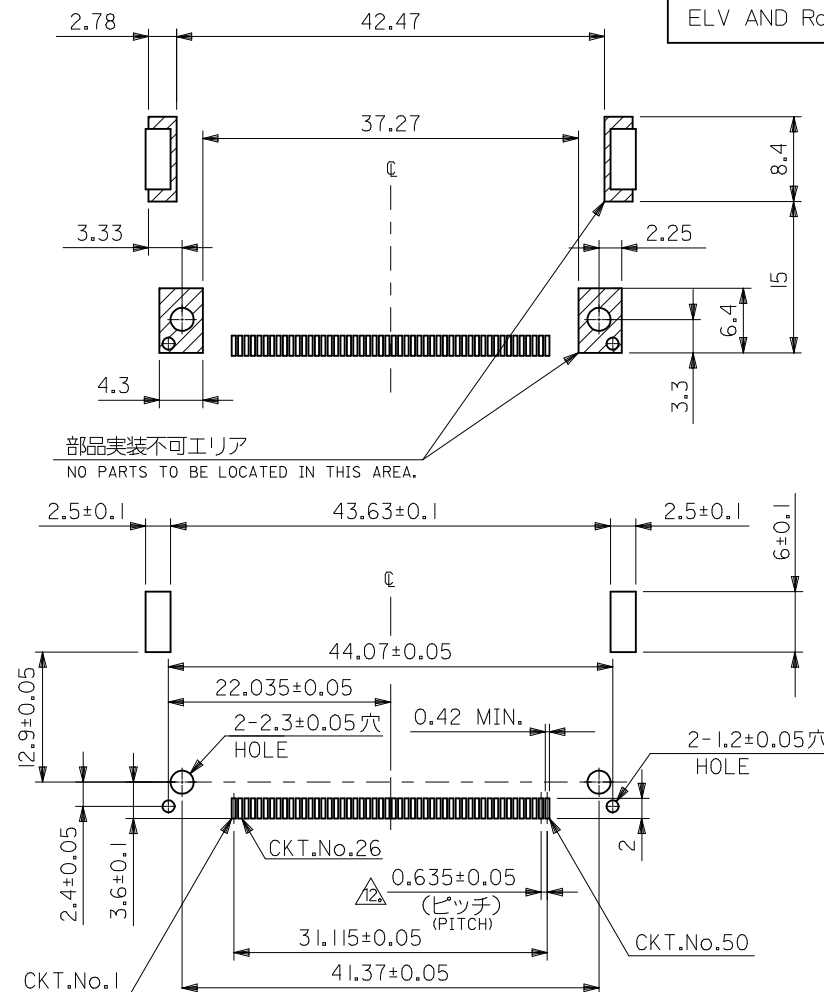
13. 本製品は 53927-***10 の鉛フリー品である。

THIS PRODUCT IS LEAD FREE OF 53927-***10.

14. 実装時、ボルトとナットを使用すること。

USE THE BOLT AND THE NUT WHEN YOU MOUNT.

ELV AND RoHS COMPLIANT.



基板推奨寸法

RECOMMENDED P.C.B. LAYOUT

REVISED	EC NO: J2014-0889	2013/11/21	DRW: NESATO	2013/11/21	CHKD: ASHIMOTSU	2013/11/21	APPR: NUKITA	2013/11/21	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION		
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